

Global Wafer Slicing Equipment Competitive Landscape Professional Research Report 2025

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Abstracts

Market Overview

According to DIResearch's in-depth investigation and research, the global Wafer Slicing Equipment market size will reach 1,053.88 Million USD in 2025 and is projected to reach 1,449.63 Million USD by 2032, with a CAGR of 4.66% (2025-2032). Notably, the China Wafer Slicing Equipment market has changed rapidly in the past few years. By 2025, China's market size is expected to be Million USD, representing approximately % of the global market share.

Research Summary

Wafer slicing equipment refers to machinery and tools used in semiconductor manufacturing to slice semiconductor ingots or boules into thin, flat wafers. This process, known as wafer slicing or wafering, is a critical step in semiconductor fabrication, as it produces the substrates on which integrated circuits and other semiconductor devices are built. Wafer slicing equipment typically includes diamond wire saws or wafering saws equipped with precision blades made of diamond or other hard materials. These saws cut semiconductor ingots into wafers with precise thickness and uniformity, ensuring consistency and quality in the resulting semiconductor devices. Wafer slicing equipment is designed to operate under controlled conditions to minimize damage to the wafers and optimize yield. It plays a crucial role in semiconductor manufacturing by enabling the mass production of high-quality semiconductor wafers for use in a wide range of electronic applications.

The major global manufacturers of Wafer Slicing Equipment include DISCO, Tokyo Seimitsu, GL Tech Co Ltd, ASM, Synova, CETC Electronics Equipment Group Co., Ltd.,

Shenyang Heyan Technology Co., Ltd., Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd., Hi-TESI, Tensun, etc. The global players competition landscape in this report is divided into three tiers. The first tier comprises global leading enterprises that command a substantial market share, hold a dominant industry position, possess strong competitiveness and influence, and generate significant revenue. The second tier includes companies with a notable market presence and reputation; these firms actively follow industry leaders in product, service, or technological innovation and maintain a moderate revenue scale. The third tier consists of smaller companies with limited market share and lower brand recognition, primarily focused on local markets and generating comparatively lower revenue.

This report studies the market size, price trends and future development prospects of Wafer Slicing Equipment. Focus on analysing the market share, product portfolio, prices, sales, revenue and gross profit margin of global major manufacturers, as well as the market status and trends of different product types and applications in the global Wafer Slicing Equipment market. The report data covers historical data from 2020 to 2024, based year in 2025 and forecast data from 2026 to 2032.

The regions and countries in the report include North America, Europe, China, APAC (excl. China), Latin America and Middle East and Africa, covering the Wafer Slicing Equipment market conditions and future development trends of key regions and countries, combined with industry-related policies and the latest technological developments, analyze the development characteristics of Wafer Slicing Equipment industries in various regions and countries, help companies understand the development characteristics of each region, help companies formulate business strategies, and achieve the ultimate goal of the company's global development strategy.

The data sources of this report mainly include the National Bureau of Statistics, customs databases, industry associations, corporate financial reports, third-party databases, etc. Among them, macroeconomic data mainly comes from the National Bureau of Statistics, International Economic Research Organization; industry statistical data mainly come from industry associations; company data mainly comes from interviews, public information collection, third-party reliable databases, and price data mainly comes from various markets monitoring database.

Global Key Manufacturers of Wafer Slicing Equipment Include:

DISCO

Tokyo Seimitsu

GL Tech Co Ltd

ASM

Synova

CETC Electronics Equipment Group Co., Ltd.

Shenyang Heyan Technology Co., Ltd.

Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.

Hi-TESE

Tensun

Wafer Slicing Equipment Product Segment Include:

Blade Cutting Machine

Laser Cutting Machine

Wafer Slicing Equipment Product Application Include:

Pure Foundry

IDM

OSAT

LED

Photovoltaic

Chapter Scope

Chapter 1: Product Research Range, Product Types and Applications, Market Overview, Market Situation and Trends

Chapter 2: Global Wafer Slicing Equipment Industry PESTEL Analysis

Chapter 3: Global Wafer Slicing Equipment Industry Porter's Five Forces Analysis

Chapter 4: Global Wafer Slicing Equipment Major Regional Market Size (Revenue, Sales, Price) and Forecast Analysis

Chapter 5: Global Wafer Slicing Equipment Market Size and Forecast by Type and Application Analysis

Chapter 6: North America Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 7: Europe Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 8: China Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 9: APAC (Excl. China) Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 10: Latin America Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 11: Middle East and Africa Wafer Slicing Equipment Competitive Analysis (Market Size, Key Players and Market Share, Product Type and Application Segment Analysis, Countries Analysis)

Chapter 12: Global Wafer Slicing Equipment Competitive Analysis of Key Manufacturers (Sales, Revenue, Market Share, Price, Regional Distribution and Industry Concentration)

Chapter 13: Key Company Profiles (Product Portfolio, Sales, Revenue, Price and Gross Margin)

Chapter 14: Industrial Chain Analysis, Include Raw Material Suppliers, Distributors and Customers

Chapter 15: Research Findings and Conclusion

Chapter 16: Methodology and Data Sources

Contents

1 WAFER SLICING EQUIPMENT MARKET OVERVIEW

- 1.1 Product Definition and Statistical Scope
- 1.2 Wafer Slicing Equipment Product by Type
 - 1.2.1 Blade Cutting Machine
 - 1.2.2 Laser Cutting Machine
- 1.3 Wafer Slicing Equipment Product by Application
 - 1.3.1 Pure Foundry
 - 1.3.2 IDM
 - 1.3.3 OSAT
 - 1.3.4 LED
 - 1.3.5 Photovoltaic
- 1.4 Global Wafer Slicing Equipment Market Revenue and Sales Analysis
 - 1.4.1 Global Wafer Slicing Equipment Revenue Market Size Analysis (2020-2032)
 - 1.4.2 Global Wafer Slicing Equipment Sales Market Size Analysis (2020-2032)
 - 1.4.3 Global Wafer Slicing Equipment Market Sales Price Trend Analysis (2020-2032)
- 1.5 Wafer Slicing Equipment Industry Trends and Innovation
 - 1.5.1 Wafer Slicing Equipment Industry Trends and Innovation
 - 1.5.2 Wafer Slicing Equipment Market Drivers and Challenges

2 WAFER SLICING EQUIPMENT MARKET PESTEL ANALYSIS

- 2.1 Political Factors Analysis
- 2.2 Economic Factors Analysis
- 2.3 Social Factors Analysis
- 2.4 Technological Factors Analysis
- 2.5 Environmental Factors Analysis
- 2.6 Legal Factors Analysis

3 WAFER SLICING EQUIPMENT MARKET PORTER'S FIVE FORCES ANALYSIS

- 3.1 Competitive Rivalry
- 3.2 Threat of New Entrants
- 3.3 Bargaining Power of Suppliers
- 3.4 Bargaining Power of Buyers
- 3.5 Threat of Substitutes

4 GLOBAL WAFER SLICING EQUIPMENT MARKET ANALYSIS BY REGIONS

- 4.1 Global Wafer Slicing Equipment Overall Market: 2024 VS 2025 VS 2032
- 4.2 Global Wafer Slicing Equipment Revenue and Forecast Analysis (2020-2032)
 - 4.2.1 Global Wafer Slicing Equipment Revenue and Market Share by Region (2020-2025)
 - 4.2.2 Global Wafer Slicing Equipment Revenue and Market Share Forecast by Region (2026-2032)
- 4.3 Global Wafer Slicing Equipment Sales and Forecast Analysis (2020-2032)
 - 4.3.1 Global Wafer Slicing Equipment Sales and Market Share by Region (2020-2025)
 - 4.3.2 Global Wafer Slicing Equipment Sales and Market Share Forecast by Region (2026-2032)
- 4.4 Global Wafer Slicing Equipment Sales Price Trend Analysis (2020-2032)

5 GLOBAL WAFER SLICING EQUIPMENT MARKET SIZE BY TYPE AND APPLICATION

- 5.1 Global Wafer Slicing Equipment Market Size by Type
 - 5.1.1 Global Wafer Slicing Equipment Revenue and Forecast Analysis by Type (2020-2032)
 - 5.1.2 Global Wafer Slicing Equipment Sales and Forecast Analysis by Type (2020-2032)
- 5.2 Global Wafer Slicing Equipment Market Size by Application
 - 5.2.1 Global Wafer Slicing Equipment Revenue and Forecast Analysis by Application (2020-2032)
 - 5.2.2 Global Wafer Slicing Equipment Sales and Forecast Analysis by Application (2020-2032)

6 NORTH AMERICA

- 6.1 North America Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)
- 6.2 North America Key Manufacturers Analysis
- 6.3 North America Wafer Slicing Equipment Market Size by Type
 - 6.3.1 North America Wafer Slicing Equipment Sales by Type (2020-2032)
 - 6.3.2 North America Wafer Slicing Equipment Revenue by Type (2020-2032)
- 6.4 North America Wafer Slicing Equipment Market Size by Application
 - 6.4.1 North America Wafer Slicing Equipment Sales by Application (2020-2032)
 - 6.4.2 North America Wafer Slicing Equipment Revenue by Application (2020-2032)

6.5 North America Wafer Slicing Equipment Market Size by Country

6.5.1 US

6.5.2 Canada

7 EUROPE

7.1 Europe Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)

7.2 Europe Key Manufacturers Analysis

7.3 Europe Wafer Slicing Equipment Market Size by Type

7.3.1 Europe Wafer Slicing Equipment Sales by Type (2020-2032)

7.3.2 Europe Wafer Slicing Equipment Revenue by Type (2020-2032)

7.4 Europe Wafer Slicing Equipment Market Size by Application

7.4.1 Europe Wafer Slicing Equipment Sales by Application (2020-2032)

7.4.2 Europe Wafer Slicing Equipment Revenue by Application (2020-2032)

7.5 Europe Wafer Slicing Equipment Market Size by Country

7.5.1 Germany

7.5.2 France

7.5.3 United Kingdom

7.5.4 Italy

7.5.5 Spain

7.5.6 Benelux

8 CHINA

8.1 China Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)

8.2 China Key Manufacturers Analysis

8.3 China Wafer Slicing Equipment Market Size by Type

8.3.1 China Wafer Slicing Equipment Sales by Type (2020-2032)

8.3.2 China Wafer Slicing Equipment Revenue by Type (2020-2032)

8.4 China Wafer Slicing Equipment Market Size by Application

8.4.1 China Wafer Slicing Equipment Sales by Application (2020-2032)

8.4.2 China Wafer Slicing Equipment Revenue by Application (2020-2032)

9 APAC (EXCL. CHINA)

9.1 APAC (excl. China) Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)

9.2 APAC (excl. China) Key Manufacturers Analysis

9.3 APAC (excl. China) Wafer Slicing Equipment Market Size by Type

9.3.1 APAC (excl. China) Wafer Slicing Equipment Sales by Type (2020-2032)

9.3.2 APAC (excl. China) Wafer Slicing Equipment Revenue by Type (2020-2032)

9.4 APAC (excl. China) Wafer Slicing Equipment Market Size by Application

9.4.1 APAC (excl. China) Wafer Slicing Equipment Sales by Application (2020-2032)

9.4.2 APAC (excl. China) Wafer Slicing Equipment Revenue by Application (2020-2032)

9.5 APAC (excl. China) Wafer Slicing Equipment Market Size by Country

9.5.1 Japan

9.5.2 South Korea

9.5.3 India

9.5.4 Australia

9.5.5 Southeast Asia

10 LATIN AMERICA

10.1 Latin America Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)

10.2 Latin America Key Manufacturers Analysis

10.3 Latin America Wafer Slicing Equipment Market Size by Type

10.3.1 Latin America Wafer Slicing Equipment Sales by Type (2020-2032)

10.3.2 Latin America Wafer Slicing Equipment Revenue by Type (2020-2032)

10.4 Latin America Wafer Slicing Equipment Market Size by Application

10.4.1 Latin America Wafer Slicing Equipment Sales by Application (2020-2032)

10.4.2 Latin America Wafer Slicing Equipment Revenue by Application (2020-2032)

10.5 Latin America Wafer Slicing Equipment Market Size by Country

10.6 Latin America Wafer Slicing Equipment Market Size by Country

10.6.1 Mexico

10.6.2 Brazil

11 MIDDLE EAST & AFRICA

11.1 Middle East & Africa Wafer Slicing Equipment Market Size and Growth Rate Analysis (2020-2032)

11.2 Middle East & Africa Key Manufacturers Analysis

11.3 Middle East & Africa Wafer Slicing Equipment Market Size by Type

11.3.1 Middle East & Africa Wafer Slicing Equipment Sales by Type (2020-2032)

11.3.2 Middle East & Africa Wafer Slicing Equipment Revenue by Type (2020-2032)

11.4 Middle East & Africa Wafer Slicing Equipment Market Size by Application

- 11.4.1 Middle East & Africa Wafer Slicing Equipment Sales by Application (2020-2032)
- 11.4.2 Middle East & Africa Wafer Slicing Equipment Revenue by Application (2020-2032)
- 11.5 Middle East Wafer Slicing Equipment Market Size by Country
 - 11.5.1 Saudi Arabia
 - 11.5.2 South Africa

12 COMPETITION BY MANUFACTURERS

- 12.1 Global Wafer Slicing Equipment Market Sales, Revenue and Price by Key Manufacturers (2021-2025)
 - 12.1.1 Global Wafer Slicing Equipment Market Sales by Key Manufacturers (2021-2025)
 - 12.1.2 Global Wafer Slicing Equipment Market Revenue by Key Manufacturers (2021-2025)
 - 12.1.3 Global Wafer Slicing Equipment Average Sales Price by Manufacturers (2021-2025)
- 12.2 Wafer Slicing Equipment Competitive Landscape Analysis and Market Dynamic
 - 12.2.1 Wafer Slicing Equipment Competitive Landscape Analysis
 - 12.2.2 Global Key Manufacturers Headquarter Location and Key Area Sales
 - 12.2.3 Market Dynamic

13 KEY COMPANIES ANALYSIS

- 13.1 DISCO
 - 13.1.1 DISCO Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.1.2 DISCO Wafer Slicing Equipment Product Portfolio
 - 13.1.3 DISCO Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.2 Tokyo Seimitsu
 - 13.2.1 Tokyo Seimitsu Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.2.2 Tokyo Seimitsu Wafer Slicing Equipment Product Portfolio
 - 13.2.3 Tokyo Seimitsu Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.3 GL Tech Co Ltd
 - 13.3.1 GL Tech Co Ltd Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

- 13.3.2 GL Tech Co Ltd Wafer Slicing Equipment Product Portfolio
- 13.3.3 GL Tech Co Ltd Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.4 ASM
 - 13.4.1 ASM Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.4.2 ASM Wafer Slicing Equipment Product Portfolio
 - 13.4.3 ASM Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.5 Synova
 - 13.5.1 Synova Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.5.2 Synova Wafer Slicing Equipment Product Portfolio
 - 13.5.3 Synova Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.6 CETC Electronics Equipment Group Co., Ltd.
 - 13.6.1 CETC Electronics Equipment Group Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.6.2 CETC Electronics Equipment Group Co., Ltd. Wafer Slicing Equipment Product Portfolio
 - 13.6.3 CETC Electronics Equipment Group Co., Ltd. Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.7 Shenyang Heyan Technology Co., Ltd.
 - 13.7.1 Shenyang Heyan Technology Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.7.2 Shenyang Heyan Technology Co., Ltd. Wafer Slicing Equipment Product Portfolio
 - 13.7.3 Shenyang Heyan Technology Co., Ltd. Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.8 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd.
 - 13.8.1 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
 - 13.8.2 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Wafer Slicing Equipment Product Portfolio
 - 13.8.3 Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)
- 13.9 Hi-TESI
 - 13.9.1 Hi-TESI Basic Company Profile (Employees, Areas Service, Competitors and

Contact Information)

13.9.2 Hi-TESE Wafer Slicing Equipment Product Portfolio

13.9.3 Hi-TESE Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

13.10 Tensun

13.10.1 Tensun Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

13.10.2 Tensun Wafer Slicing Equipment Product Portfolio

13.10.3 Tensun Wafer Slicing Equipment Market Data Analysis (Revenue, Sales, Price, Gross Margin and Market Share) (2021-2025)

14 INDUSTRY CHAIN ANALYSIS

14.1 Wafer Slicing Equipment Industry Chain Analysis

14.2 Wafer Slicing Equipment Industry Raw Material and Suppliers Analysis

14.2.1 Wafer Slicing Equipment Key Raw Material Supply Analysis

14.2.2 Raw Material Suppliers and Contact Information

14.3 Wafer Slicing Equipment Typical Downstream Customers

14.4 Wafer Slicing Equipment Sales Channel Analysis

15 RESEARCH FINDINGS AND CONCLUSION

16 METHODOLOGY AND DATA SOURCE

16.1 Methodology/Research Approach

16.2 Research Scope

16.3 Benchmarks and Assumptions

16.4 Data Source

16.4.1 Primary Sources

16.4.2 Secondary Sources

16.5 Data Cross Validation

16.6 Disclaimer

List Of Tables

LIST OF TABLES

Table 1: Global Wafer Slicing Equipment Market Size Growth Rate by Type, 2024 VS 2025 VS 2032 (US\$ Million)

Table 2: Global Wafer Slicing Equipment Market Size Growth Rate by Application, 2024 VS 2025 VS 2032 (US\$ Million)

Table 3: Wafer Slicing Equipment Industry Development Status

Table 4: Wafer Slicing Equipment Industry Development Trends

Table 5: Global Wafer Slicing Equipment Market Size by Region in US\$ Million: 2024 VS 2025 VS 2032

Table 6: Global Wafer Slicing Equipment Revenue by Region (2020-2025) & (US\$ Million)

Table 7: Global Wafer Slicing Equipment Revenue Market Share by Region (2020-2025)

Table 8: Global Wafer Slicing Equipment Revenue Forecast by Region (2026-2032) & (US\$ Million)

Table 9: Global Wafer Slicing Equipment Revenue Market Share Forecast by Region (2026-2032)

Table 10: Global Wafer Slicing Equipment Sales by Region (2020-2025) & (Units)

Table 11: Global Wafer Slicing Equipment Sales Market Share by Region (2020-2025)

Table 12: Global Wafer Slicing Equipment Sales Forecast by Region (2026-2032) & (Units)

Table 13: Global Wafer Slicing Equipment Sales Market Share Forecast by Region (2026-2032)

Table 14: Global Wafer Slicing Equipment Revenue Analysis by Type (2020-2025) & (US\$ Million)

Table 15: Global Wafer Slicing Equipment Revenue Analysis Forecast by Type (2026-2032) & (US\$ Million)

Table 16: Global Wafer Slicing Equipment Sales Analysis by Type (2020-2025) & (Units)

Table 17: Global Wafer Slicing Equipment Sales Analysis Forecast by Type (2026-2032) & (Units)

Table 18: Global Wafer Slicing Equipment Revenue Analysis by Application (2020-2025) & (US\$ Million)

Table 19: Global Wafer Slicing Equipment Revenue Analysis Forecast by Application (2026-2032) & (US\$ Million)

Table 20: Global Wafer Slicing Equipment Sales Analysis by Application (2020-2025) &

(Units)

Table 21: Global Wafer Slicing Equipment Sales Analysis Forecast by Application (2026-2032) & (Units)

Table 22: Key Wafer Slicing Equipment Players in North America

Table 23: North America Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 24: North America Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 25: North America Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 26: North America Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 27: North America Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)

Table 28: North America Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)

Table 29: North America Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 30: North America Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 31: North America Wafer Slicing Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 32: North America Wafer Slicing Equipment Revenue Market Size by Country (2026-2032) & (US\$ Million)

Table 33: North America Wafer Slicing Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 34: North America Wafer Slicing Equipment Sales Market Size by Country (2026-2032) & (Units)

Table 35: Key Wafer Slicing Equipment Players in Europe

Table 36: Europe Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 37: Europe Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 38: Europe Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 39: Europe Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 40: Europe Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)

Table 41: Europe Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)

Table 42: Europe Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 43: Europe Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 44: Europe Wafer Slicing Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 45: Europe Wafer Slicing Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 46: Europe Wafer Slicing Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 47: Europe Wafer Slicing Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 48: Key Wafer Slicing Equipment Players in China

Table 49: China Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 50: China Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 51: China Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 52: China Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 53: China Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)

Table 54: China Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)

Table 55: China Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 56: China Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 57: Key Wafer Slicing Equipment Players in APAC (excl. China)

Table 58: APAC (excl. China) Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 59: APAC (excl. China) Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 60: APAC (excl. China) Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 61: APAC (excl. China) Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 62: APAC (excl. China) Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)

Table 63: APAC (excl. China) Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)

Table 64: APAC (excl. China) Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 65: APAC (excl. China) Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 66: APAC (excl. China) Wafer Slicing Equipment Revenue Market Size by

Country (2020-2025) & (US\$ Million)

Table 67: APAC (excl. China) Wafer Slicing Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 68: APAC (excl. China) Wafer Slicing Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 69: APAC (excl. China) Wafer Slicing Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 70: Key Wafer Slicing Equipment Players in Latin America

Table 71: Latin America Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 72: Latin America Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 73: Latin America Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 74: Latin America Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

Table 75: Latin America Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)

Table 76: Latin America Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)

Table 77: Latin America Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)

Table 78: Latin America Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)

Table 79: Latin America Wafer Slicing Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)

Table 80: Latin America Wafer Slicing Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)

Table 81: Latin America Wafer Slicing Equipment Sales Market Size by Country (2020-2025) & (Units)

Table 82: Latin America Wafer Slicing Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)

Table 83: Key Wafer Slicing Equipment Players in Middle East & Africa

Table 84: Middle East & Africa Wafer Slicing Equipment Sales by Type (2020-2025) & (Units)

Table 85: Middle East & Africa Wafer Slicing Equipment Sales by Type (2026-2032) & (Units)

Table 86: Middle East & Africa Wafer Slicing Equipment Revenue by Type (2020-2025) & (US\$ Million)

Table 87: Middle East & Africa Wafer Slicing Equipment Revenue by Type (2026-2032) & (US\$ Million)

- Table 88: Middle East & Africa Wafer Slicing Equipment Sales by Application (2020-2025) & (Units)
- Table 89: Middle East & Africa Wafer Slicing Equipment Sales by Application (2026-2032) & (Units)
- Table 90: Middle East & Africa Wafer Slicing Equipment Revenue by Application (2020-2025) & (US\$ Million)
- Table 91: Middle East & Africa Wafer Slicing Equipment Revenue by Application (2026-2032) & (US\$ Million)
- Table 92: Middle East & Africa Wafer Slicing Equipment Revenue Market Size by Country (2020-2025) & (US\$ Million)
- Table 93: Middle East & Africa Wafer Slicing Equipment Revenue Market Size Forecast by Country (2026-2032) & (US\$ Million)
- Table 94: Middle East & Africa Wafer Slicing Equipment Sales Market Size by Country (2020-2025) & (Units)
- Table 95: Middle East & Africa Wafer Slicing Equipment Sales Market Size Forecast by Country (2026-2032) & (Units)
- Table 96: Global Wafer Slicing Equipment Market Sales by Key Manufacturers (2021-2025) & (Units)
- Table 97: Global Wafer Slicing Equipment Sales Market Share by Key Manufacturers (2021-2025)
- Table 98: Global Wafer Slicing Equipment Market Revenue by Key Manufacturers (2021-2025) & (US\$ Million)
- Table 99: Global Wafer Slicing Equipment Revenue Market Share by Key Manufacturers (2021-2025)
- Table 100: Global Average Sales Price by Manufacturers (2021-2025) & (USD/Unit)
- Table 101: Global Key Manufacturers Headquarter Location and Key Area Sales
- Table 102: Market Mergers & Acquisitions, Expansion
- Table 103: DISCO Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
- Table 104: DISCO Wafer Slicing Equipment Product Portfolio
- Table 105: DISCO Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)
- Table 106: Tokyo Seimitsu Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)
- Table 107: Tokyo Seimitsu Wafer Slicing Equipment Product Portfolio
- Table 108: Tokyo Seimitsu Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)
- Table 109: GL Tech Co Ltd Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 110: GL Tech Co Ltd Wafer Slicing Equipment Product Portfolio

Table 111: GL Tech Co Ltd Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 112: ASM Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 113: ASM Wafer Slicing Equipment Product Portfolio

Table 114: ASM Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 115: Synova Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 116: Synova Wafer Slicing Equipment Product Portfolio

Table 117: Synova Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 118: CETC Electronics Equipment Group Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 119: CETC Electronics Equipment Group Co., Ltd. Wafer Slicing Equipment Product Portfolio

Table 120: CETC Electronics Equipment Group Co., Ltd. Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 121: Shenyang Heyan Technology Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 122: Shenyang Heyan Technology Co., Ltd. Wafer Slicing Equipment Product Portfolio

Table 123: Shenyang Heyan Technology Co., Ltd. Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 124: Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 125: Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Wafer Slicing Equipment Product Portfolio

Table 126: Jiangsu Jingchuang Advanced Electronic Technology Co., Ltd. Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 127: Hi-TESI Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 128: Hi-TESI Wafer Slicing Equipment Product Portfolio

Table 129: Hi-TESI Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 130: Tensun Basic Company Profile (Employees, Areas Service, Competitors and Contact Information)

Table 131: Tensun Wafer Slicing Equipment Product Portfolio

Table 132: Tensun Wafer Slicing Equipment Revenue (US\$ Million), Sales (Units), Price (USD/Unit), Gross Margin and Market Share (2021-2025)

Table 133: Upstream Key Raw Material Price List

Table 134: Wafer Slicing Equipment Raw Material Suppliers and Contact Information

Table 135: Wafer Slicing Equipment Typical Customer List

Table 136: Wafer Slicing Equipment Distributors List

List Of Figures

LIST OF FIGURES

Figure 1: Wafer Slicing Equipment Product Pictures

Figure 2: Blade Cutting Machine Picture Scope

Figure 3: Laser Cutting Machine Picture Scope

Figure 4: Pure Foundry Picture Scope

Figure 5: IDM Picture Scope

Figure 6: OSAT Picture Scope

Figure 7: LED Picture Scope

Figure 8: Photovoltaic Picture Scope

Figure 9: Global Wafer Slicing Equipment Market Size Analysis: 2024 VS 2025 VS 2032 (US\$ Million)

Figure 10: Global Wafer Slicing Equipment Market Revenue and Growth Rate Analysis: (2020-2032) & (US\$ Million)

Figure 11: Global Wafer Slicing Equipment Market Sales and Growth Rate Analysis (2020-2032) & (Units)

Figure 12: Global Wafer Slicing Equipment Market Price Trend Analysis (2020-2032) & (USD/Unit)

Figure 13: Global Wafer Slicing Equipment Market Size by Region (2020-2032) & (US\$ Million)

Figure 14: Global Wafer Slicing Equipment Market Share Scenario by Region in Percentage: 2025 Versus 2032

Figure 15: Global Wafer Slicing Equipment Sales Price by Region (2020-2032) & (Units)

Figure 16: North America Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 17: North America Wafer Slicing Equipment Revenue Market Share by Players in 2024

Figure 18: North America Wafer Slicing Equipment Sales Market Share by Type (2020-2032)

Figure 19: North America Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)

Figure 20: North America Wafer Slicing Equipment Sales Market Share by Application (2020-2032)

Figure 21: North America Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)

Figure 22: US Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 23: Canada Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 24:Europe Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 25:Europe Wafer Slicing Equipment Revenue Market Share by Players in 2024

Figure 26:Europe Wafer Slicing Equipment Sales Market Share by Type (2020-2032)

Figure 27:Europe Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)

Figure 28:Europe Wafer Slicing Equipment Sales Market Share by Application (2020-2032)

Figure 29:Europe Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)

Figure 30:Germany Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 31:France Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 32:United Kingdom Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 33:Italy Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 34:Spain Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 35:Benelux Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

Figure 36:China Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 37:China Wafer Slicing Equipment Revenue Market Share by Players in 2024

Figure 38:China Wafer Slicing Equipment Sales Market Share by Type (2020-2032)

Figure 39:China Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)

Figure 40:China Wafer Slicing Equipment Sales Market Share by Application (2020-2032)

Figure 41:China Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)

Figure 42:APAC (excl. China) Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)

Figure 43:APAC (excl. China) Wafer Slicing Equipment Revenue Market Share by Players in 2024

Figure 44:APAC (excl. China) Wafer Slicing Equipment Sales Market Share by Type (2020-2032)

Figure 45:APAC (excl. China) Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)

Figure 46:APAC (excl. China) Wafer Slicing Equipment Sales Market Share by Application (2020-2032)

Figure 47:APAC (excl. China) Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)

Figure 48:Japan Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)

- Figure 49:South Korea Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 50:India Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 51:Australia Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 52:Southeast Asia Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 53:Latin America Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)
- Figure 54:Latin America Wafer Slicing Equipment Revenue Market Share by Players in 2024
- Figure 55:Latin America Wafer Slicing Equipment Sales Market Share by Type (2020-2032)
- Figure 56:Latin America Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)
- Figure 57:Latin America Wafer Slicing Equipment Sales Market Share by Application (2020-2032)
- Figure 58:Latin America Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)
- Figure 59:Mexico Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 60:Brazil Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 61:Middle East & Africa Wafer Slicing Equipment Market Size and Growth Rate (2020-2032) & (US\$ Million)
- Figure 62:Middle East & Africa Wafer Slicing Equipment Revenue Market Share by Players in 2024
- Figure 63:Middle East & Africa Wafer Slicing Equipment Sales Market Share by Type (2020-2032)
- Figure 64:Middle East & Africa Wafer Slicing Equipment Revenue Market Share by Type (2020-2032)
- Figure 65:Middle East & Africa Wafer Slicing Equipment Sales Market Share by Application (2020-2032)
- Figure 66:Middle East & Africa Wafer Slicing Equipment Revenue Market Share by Application (2020-2032)
- Figure 67:Saudi Arabia Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 68:South Africa Wafer Slicing Equipment Revenue (2020-2032) & (US\$ Million)
- Figure 69:Global Wafer Slicing Equipment Sales Market Share by Key Manufacturers in 2024
- Figure 70:Global Wafer Slicing Equipment Revenue Market Share by Key Manufacturers in 2024
- Figure 71:Global Wafer Slicing Equipment Industry Competition Landscape
- Figure 72:Wafer Slicing Equipment Industry Chain Analysis

Figure 73:Bottom-Up and Top-Down Research Methods

Figure 74:Key Interview Objectives

Figure 75:Data Cross Validation

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